

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

Sound Processor with Built-in 2-band Equalizer

BD37514FS

General Description

BD37514FS is a sound processor with built-in 2-band equalizer for car audio. The functions are 4ch stereo input selector, input-gain control, main volume, loudness, and 5ch fader volume. Moreover, its "Advanced switch circuit", which is an original ROHM technology, can reduce various switching noise (ex. No-signal, low frequency like 20Hz & large signal inputs). "Advanced switch" makes control of microcomputer easier, supporting the construction of a high quality car audio system.

Features

- Reduce switching noise of input gain control, mute, main volume, fader volume, bass, treble, loudness by using advanced switch circuit.
- Built-in 1 differential input selector and 3 single-ended input selectors
- Built-in ground isolation amplifier inputs, ideal for external stereo input.
- Built-in input gain controller reduces switching noise for volume of a portable audio input.
- Decrease the number of external components due to built-in 2-band equalizer filter and loudness filter. Also, it is possible to control Q, Gv, fo of 2-band equalizer, and Gv of loudness using I²C BUS control.
- It is possible to adjust the gain of the bass and treble up to ± 20 dB with 1 dB step gain adjustment.
- It is equipped with output terminals of Subwoofer.
- Energy-saving design resulting in low current consumption, by utilizing the Bi-CMOS process. It has the advantage in quality over scaling down the power heat control of the internal regulators.
- Input terminals and output terminals are organized and separately laid out to keep the signal flow in one direction which results in simpler and smaller PCB layout.
- It is possible to control the I²C BUS by 3.3V / 5V.

Key Specifications

■ Power Supply Voltage Range:	7.0V to 9.5V
■ Circuit Current (No Signal):	38mA(Typ)
■ Total Harmonic Distortion 1:	
(FRONT,REAR)	0.001%(Typ)
■ Total Harmonic Distortion 2:	
(SUBWOOFER)	0.002%(Typ)
■ Maximum Input Voltage:	2.3Vrms(Typ)
■ Cross-talk between Selectors:	-100dB(Typ)
■ Volume Control Range:	+15dB to -79dB
■ Output Noise Voltage1:	
(FRONT,REAR)	3.8 μ Vrms(Typ)
■ Output Noise Voltage2:	
(SUBWOOFER)	4.8 μ Vrms(Typ)
■ Residual Output Noise Voltage:	1.8 μ Vrms(Typ)
■ Operating Temperature Range:	-40°C to +85°C

Package

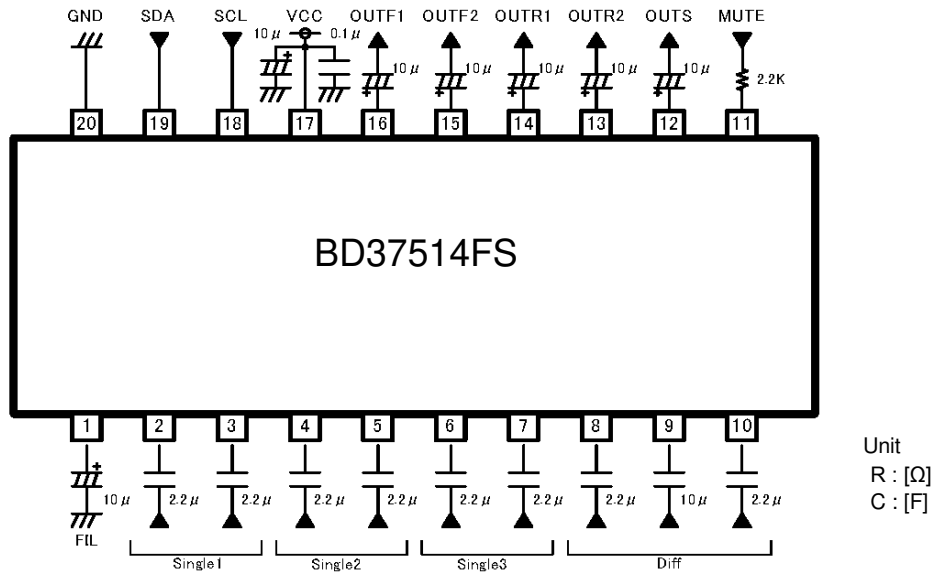
W(Typ) x D(Typ) x H(Max)



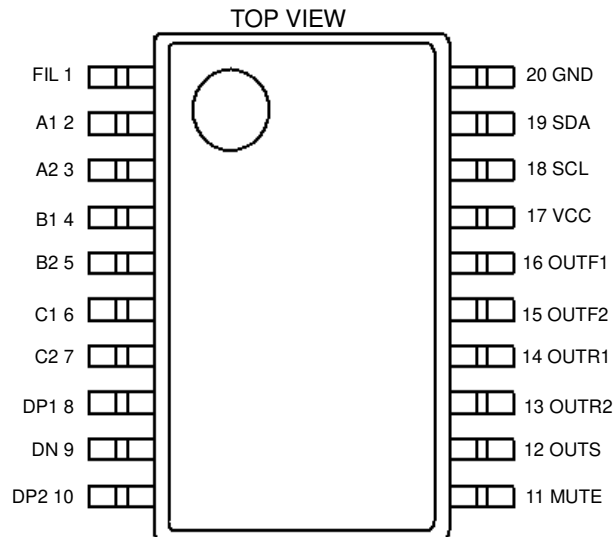
Applications

It is optimal for use in car audio systems. It can also be used for audio equipment of mini Compo, micro Compo, TV, etc.

Typical Application Circuit



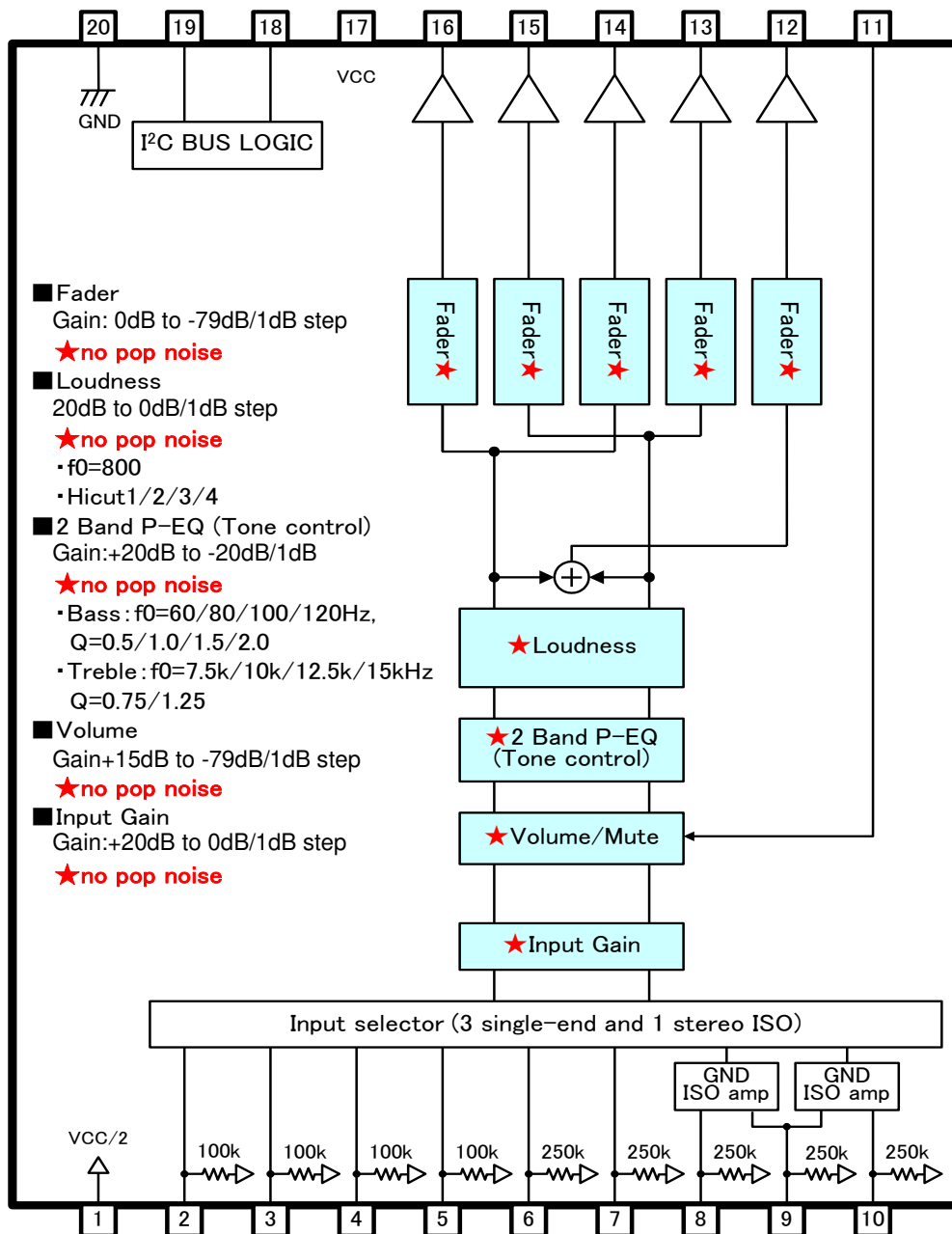
Pin Configuration



Pin Descriptions

Pin No.	Pin Name	Description	Pin No.	Pin Name	Description
1	FIL	VCC/2 terminal	11	MUTE	External compulsory mute terminal
2	A1	A input terminal of 1ch	12	OUTS	Subwoofer output terminal
3	A2	A input terminal of 2ch	13	OUTR2	Rear output terminal of 2ch
4	B1	B input terminal of 1ch	14	OUTR1	Rear output terminal of 1ch
5	B2	B input terminal of 2ch	15	OUTF2	Front output terminal of 2ch
6	C1	C input terminal of 1ch	16	OUTF1	Front output terminal of 1ch
7	C2	C input terminal of 2ch	17	VCC	Power supply terminal
8	DP1	D positive input terminal of 1ch	18	SCL	I ² C Communication clock terminal
9	DN	D negative input terminal	19	SDA	I ² C Communication data terminal
10	DP2	D positive input terminal of 2ch	20	GND	GND terminal

Block Diagram



Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Power Supply Voltage	V _{CC}	10.0	V
Input Voltage	V _{IN}	V _{CC} +0.3 to GND-0.3	V
Power Dissipation	P _d	0.94 (Note)	W
Storage Temperature	T _{stg}	-55 to +150	°C

(Note) This value derates by 7.5mW/°C for Ta=25°C or more when ROHM standard board is used.

Thermal resistance θ_{ja} = 133.3(°C/W)

ROHM Standard board

Size :70 x 70 x 1.6(mm³)

Material : A FR4 grass epoxy board(3% or less of copper foil area)

Caution: Operating the IC over the absolute maximum ratings may damage the IC. The damage can either be a short circuit between pins or an open circuit between pins and the internal circuitry. Therefore, it is important to consider circuit protection measures, such as adding a fuse, in case the IC is operated over the absolute maximum ratings.

Recommended Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Power Supply Voltage	V _{CC}	7.0	-	9.5	V
Temperature	Topr	-40	-	+85	V

Electrical Characteristics

(Unless specified otherwise, Ta=25°C, V_{CC}=8.5V, f=1kHz, V_{IN}=1Vrms, R_g=600Ω, R_L=10kΩ, A input, Input gain 0dB, Mute OFF, Volume 0dB, Tone control 0dB, Loudness 0dB, Fader 0dB)

BLOCK	Parameter	Symbol	Limit			Unit	Conditions
			Min	Typ	Max		
GENERAL	Circuit Current	I _Q	-	38	48	mA	No signal
	Voltage Gain	G _V	-1.5	0	+1.5	dB	G _V =20log(V _{OUT} /V _{IN})
	Channel Balance	CB	-1.5	0	+1.5	dB	CB = G _{V1} -G _{V2}
	Total Harmonic Distortion 1 (FRONT,REAR)	THD+N1	-	0.001	0.05	%	V _{OUT} =1Vrms BW=400Hz-30KHz
	Total Harmonic Distortion 2 (SUBWOOFER)	THD+N2	-	0.002	0.05	%	V _{OUT} =1Vrms BW=400Hz-30kHz
	Output Noise Voltage 1 (FRONT,REAR) *	V _{NO1}	-	3.8	15	μVrms	R _g = 0Ω BW = IHF-A
	Output Noise Voltage 2 (SUBWOOFER) *	V _{NO2}	-	4.8	15	μVrms	R _g = 0Ω BW = IHF-A
	Residual Output Noise Voltage *	V _{NOR}	-	1.8	10	μVrms	Fader = -∞dB R _g = 0Ω BW = IHF-A
	Cross-talk Between Channels *	CTC	-	-100	-90	dB	R _g = 0Ω CTC=20log(V _{OUT} /V _{IN}) BW = IHF-A
Ripple Rejection	RR	-	-70	-40	dB	f=1kHz V _{RR} =100mVrms RR=20log(V _{CC} IN/V _{OUT})	
INPUT SELECTOR	Input Impedance(A,B)	R _{IN_S}	70	100	130	kΩ	
	Input Impedance (C,D)	R _{IN_D}	175	250	325	kΩ	
	Maximum Input Voltage	V _{IM}	2.1	2.3	-	Vrms	V _{IM} at THD+N(V _{OUT})=1% BW=400Hz-30KHz
	Cross-talk Between Selectors *	CTS	-	-100	-90	dB	R _g = 0Ω CTS=20log(V _{OUT} /V _{IN}) BW = IHF-A
	Common Mode Rejection Ratio *	CMRR	50	65	-	dB	DP1 and DN input DP2 and DN input CMRR=20log(V _{IN} /V _{OUT}) BW = IHF-A
INPUT GAIN	Minimum Input Gain	G _{IN_MIN}	-2	0	+2	dB	Input gain 0dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
	Maximum Input Gain	G _{IN_MAX}	+18	+20	+22	dB	Input gain 20dB V _{IN} =100mVrms G _{IN} =20log(V _{OUT} /V _{IN})
	Gain Set Error	G _{IN_ERR}	-2	0	+2	dB	G _{AIN} =+1dB to +20dB
MUTE	Mute Attenuation *	G _{MUTE}	-	-105	-85	dB	Mute ON G _{MUTE} =20log(V _{OUT} /V _{IN}) BW = IHF-A

Electrical Characteristics - continued

(Unless specified otherwise, $T_a=25^\circ\text{C}$, $V_{CC}=8.5\text{V}$, $f=1\text{kHz}$, $V_{IN}=1\text{Vrms}$, $R_g=600\Omega$, $R_L=10\text{k}\Omega$, A input, Input gain 0dB, Mute OFF, Volume 0dB, Tone control 0dB, Loudness 0dB, Fader 0dB)

BLOCK	Parameter	Symbol	Limit			Unit	Conditions
			Min	Typ	Max		
VOLUME	Maximum Gain	G_{V_MAX}	+13	+15	+17	dB	Volume = 15dB $V_{IN}=100\text{mVrms}$ $G_V=20\log(V_{OUT}/V_{IN})$
	Maximum Attenuation *	G_{V_MIN}	-	-100	-85	dB	Volume = $-\infty\text{dB}$ $G_V=20\log(V_{OUT}/V_{IN})$ BW = IHF-A
	Attenuation Set Error 1	G_{V_ERR1}	-2	0	+2	dB	GAIN & ATT=+15dB to -15dB
	Attenuation Set Error 2	G_{V_ERR2}	-3	0	+3	dB	ATT=-16dB to -47dB
	Attenuation Set Error 3	G_{V_ERR3}	-4	0	+4	dB	ATT=-48dB to -79dB
BASS	Maximum Boost Gain	G_{B_BST}	+18	+20	+22	dB	GAIN=+20dB $f=100\text{Hz}$ $V_{IN}=100\text{mVrms}$ $G_B=20\log(V_{OUT}/V_{IN})$
	Maximum Cut Gain	G_{B_CUT}	-22	-20	-18	dB	GAIN=-20dB $f=100\text{Hz}$ $V_{IN}=2\text{Vrms}$ $G_B=20\log(V_{OUT}/V_{IN})$
	Gain Set Error	G_{B_ERR}	-2	0	+2	dB	Gain=+20dB to -20dB $f=100\text{Hz}$
TREBLE	Maximum Boost Gain	G_{T_BST}	+18	+20	+22	dB	Gain=+20dB $f=10\text{kHz}$ $V_{IN}=100\text{mVrms}$ $G_T=20\log(V_{OUT}/V_{IN})$
	Maximum Cut Gain	G_{T_CUT}	-23	-20	-17	dB	Gain=-20dB $f=10\text{kHz}$ $V_{IN}=2\text{Vrms}$ $G_T=20\log(V_{OUT}/V_{IN})$
	Gain set Error	G_{T_ERR}	-2	0	+2	dB	Gain=+20dB to -20dB $f=10\text{kHz}$
FADER / SUBWOOFER	Maximum Attenuation*	G_{F_MIN}	-	-100	-90	dB	Fader = $-\infty\text{dB}$ $G_F=20\log(V_{OUT}/V_{IN})$ BW = IHF-A
	Attenuation Set Error 1	G_{F_ERR1}	-2	0	+2	dB	ATT=0dB to -15dB
	Attenuation Set Error 2	G_{F_ERR2}	-3	0	+3	dB	ATT=-16dB to -47dB
	Attenuation Set Error 3	G_{F_ERR3}	-4	0	+4	dB	ATT=-48dB to -79dB
	Output Impedance	R_{OUT}	-	-	50	Ω	$V_{IN}=100\text{mVrms}$
	Maximum Output Voltage	V_{OM}	2	2.2	-	Vrms	THD+N=1% BW=400Hz-30KHz
LOUDNESS	Maximum Gain	G_{L_MAX}	+17	+20	+23	dB	Gain 20dB $V_{IN}=100\text{mVrms}$ $G_L=20\log(V_{OUT}/V_{IN})$
	Gain Set Error	G_{L_ERR}	-2	0	+2	dB	GAIN=+20dB to +1dB

VP-9690A(Average value detection, effective value display) filter by Matsushita Communication is used for * measurement.

Phase between input / output is same.

Typical Performance Curves

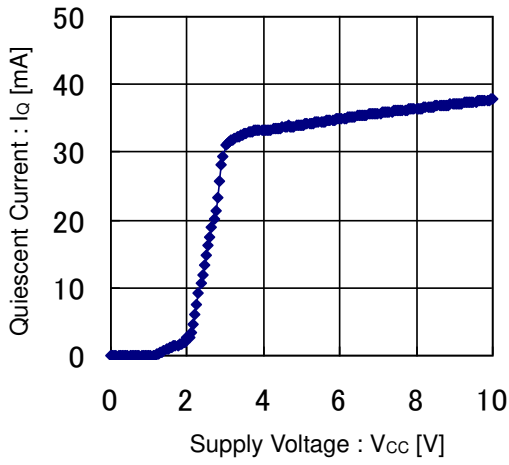


Figure 1. Quiescent Current vs Supply Voltage

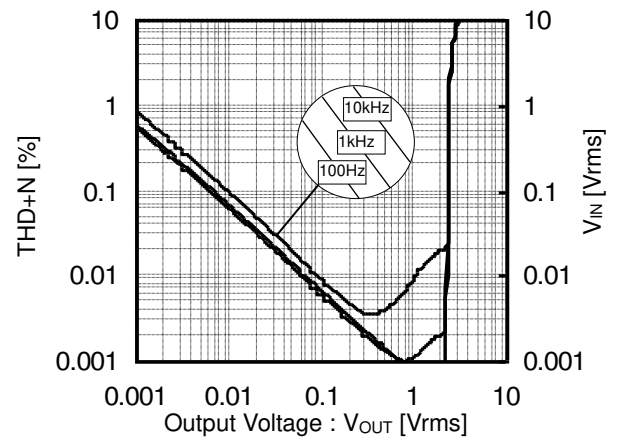


Figure 2. Total Harmonic Distortion vs Output Voltage

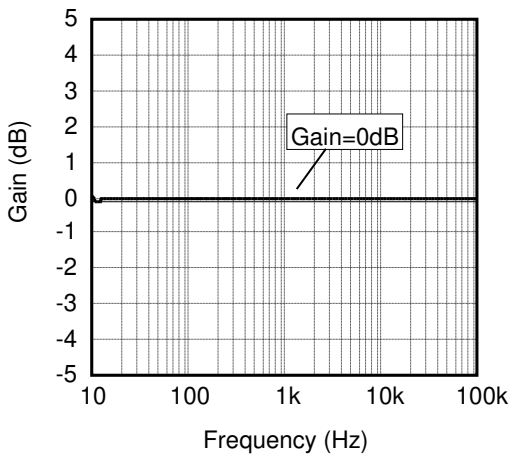
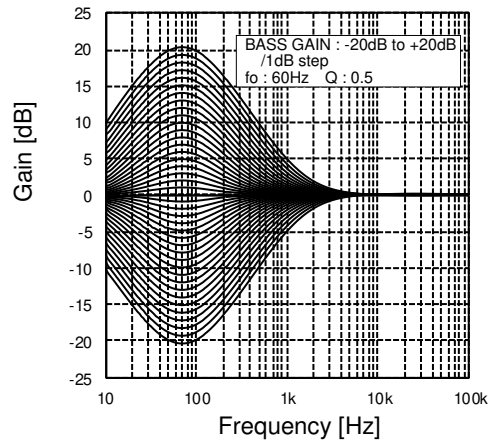


Figure 3. Gain vs Frequency



Typical Performance Curves - continued

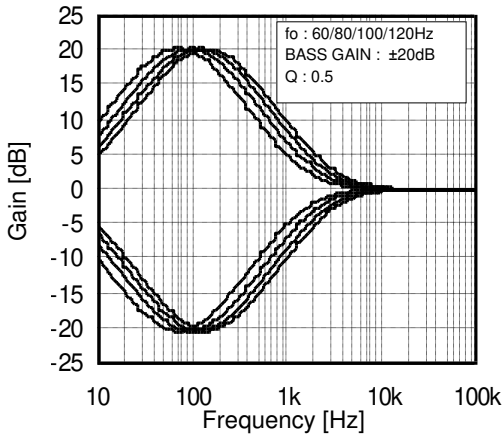


Figure 5. Bass fo vs Frequency (Bass fo is Changeable)

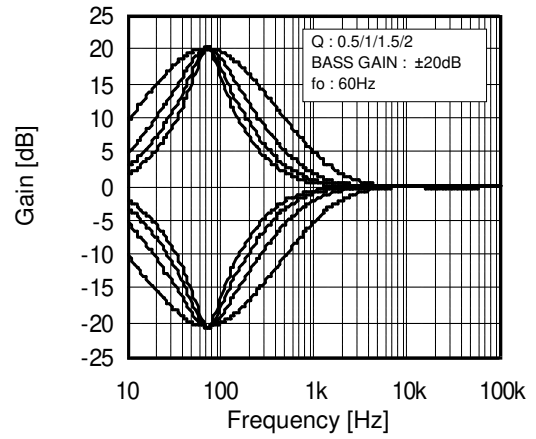


Figure 6. B Bass Q vs Frequency (Bass Q is Changeable)

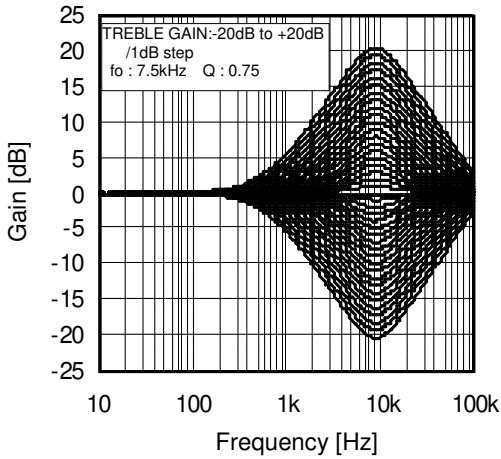


Figure 7. Treble Gain vs Frequency

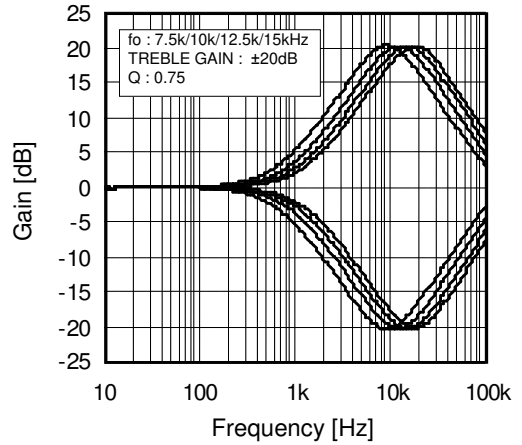


Figure 8. Treble fo vs Frequency (Treble fo is Changeable)

Typical Performance Curves - continued

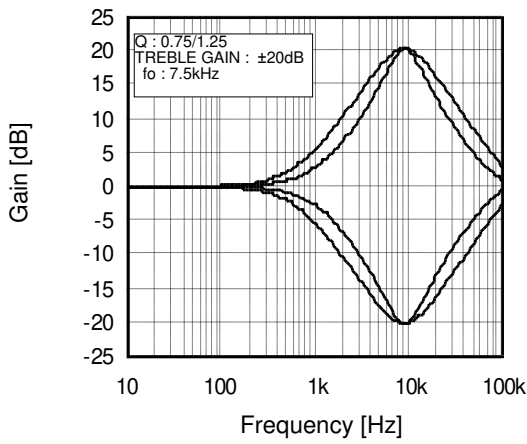


Figure 9. Treble Q vs Frequency (Treble Q is changeable)

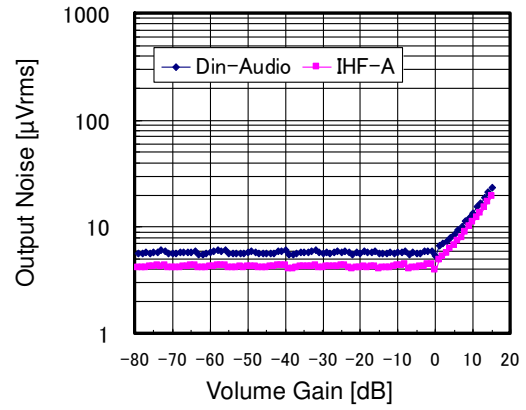


Figure 10. Output Noise vs Volume Gain

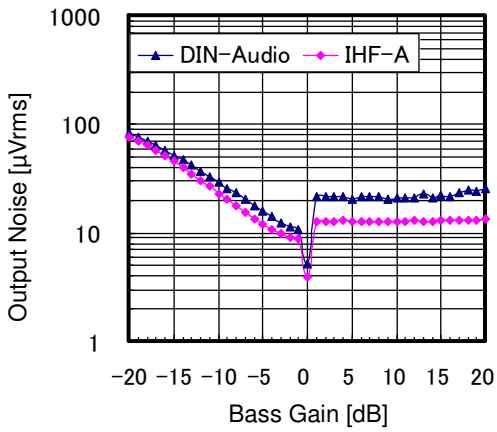


Figure 11. Output Noise vs Bass Gain

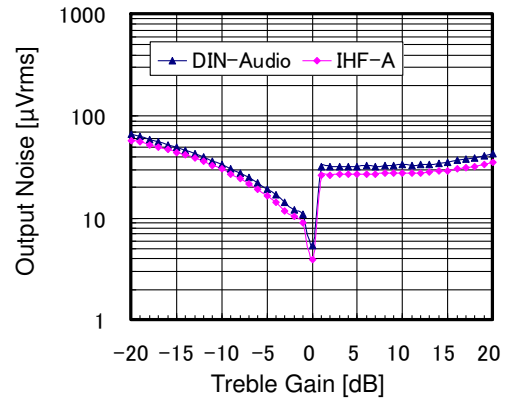


Figure 12. Output Noise vs Treble Gain

Typical Performance Curves - continued

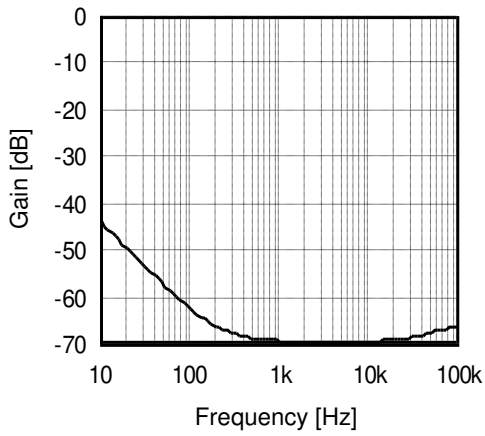


Figure 13. CMRR vs Frequency

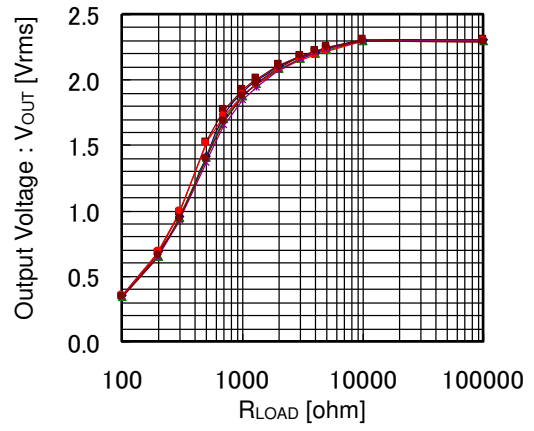


Figure 14. Output Voltage vs R_LOAD

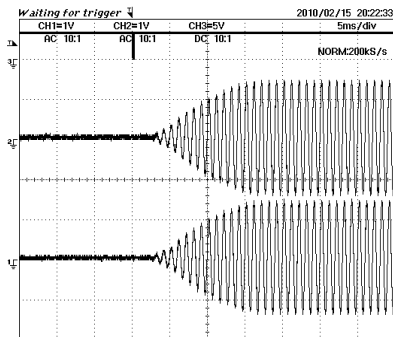


Figure 15. Advanced Switch 1

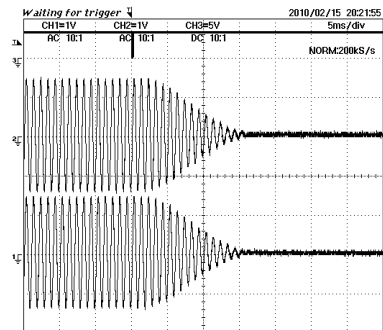


Figure 16. Advanced Switch 2

Timing Chart

Control Signal Specification

(1) Electrical Specifications and Timing for Bus Lines and I/O Stage

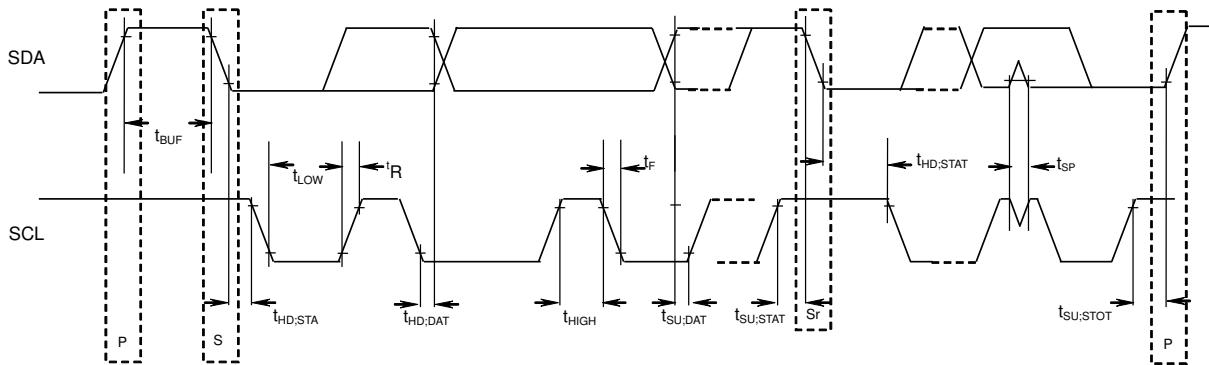


Figure 17. I²C-bus Signal Timing Diagram

Table 1 Characteristics of the SDA and SCL bus lines for I²C-bus devices (Unless specified otherwise, Ta=25°C, VCC=8.5V)

Parameter	Symbol	Fast-mode I²C-bus		Unit
		Min	Max	
1 SCL clock frequency	f _{SCL}	0	400	kHz
2 Bus free time between a STOP and START condition	t _{BUF}	1.3	-	µS
3 Hold time (repeated) START condition. After this period, the first clock pulse is generated	t _{HD,STA}	0.6	-	µS
4 LOW period of the SCL clock	t _{LOW}	1.3	-	µS
5 HIGH period of the SCL clock	t _{HIGH}	0.6	-	µS
6 Set-up time for a repeated START condition	t _{SU,STA}	0.6	-	µS
7 Data hold time:	t _{HD,DAT}	0.06 (Note)	-	µS
8 Data set-up time	t _{SU,DAT}	120	-	ns
9 Set-up time for STOP condition	t _{SU,STO}	0.6	-	µS

All values referred to VIH Min and VIL Max Levels (see Table 2).

(Note) To avoid sending right after the fall-edge of SCL (VIH min of the SCL signal), the transmitting device should set a hold time of 300ns or more for the SDA signal.
For 7(t_{HD,DAT}), 8(t_{SU,DAT}), make the setup in which the margin is fully in.

Table 2 Characteristics of the SDA and SCL I/O stages for I²C-bus devices

Parameter	Symbol	Fast-mode devices		Unit
		Min	Max	
10 LOW level input voltage:	V _{IL}	-0.3	+1	V
11 HIGH level input voltage:	V _{IH}	2.3	5	V
12 Pulse width of spikes which must be suppressed by the input filter.	t _{SP}	0	50	ns
13 LOW level output voltage: at 3mA sink current	V _{OL1}	0	0.4	V
14 Input current of each I/O pin with an input voltage between 0.4V and 4.5V.	I _I	-10	+10	µA

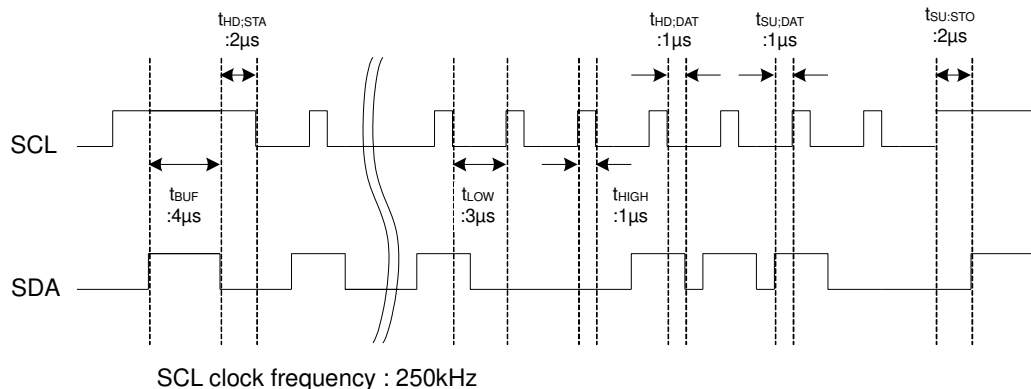
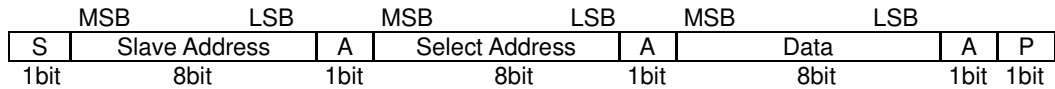


Figure 18. I²C Data Transmission Command Timing Diagram

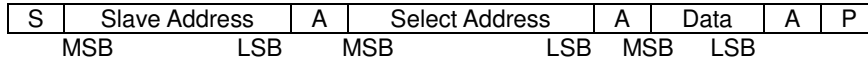
(2) I²C BUS FORMAT



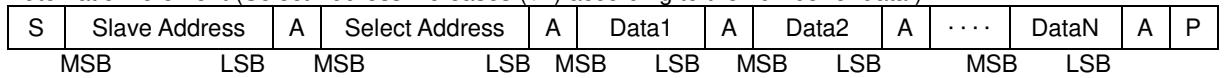
- S = Start condition (Recognition of start bit)
- Slave Address = Recognition of slave address. The first 7 bits correspond to the slave address. The least significant bit is "L" which corresponds to write mode.
- A = ACKNOWLEDGE bit (Recognition of acknowledgement)
- Select Address = Select address corresponding to volume, bass or treble.
- Data = Data on every volume and tone.
- P = Stop condition (Recognition of stop bit)

(3) I²C BUS Interface Protocol

(a) Basic Format

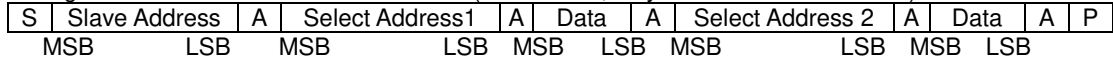


(b) Automatic Increment (Select Address increases (+1) according to the number of data.)



- (Example)
- ① Data1 shall be set as data of address specified by Select Address.
 - ② Data2 shall be set as data of address specified by Select Address +1.
 - ③ DataN shall be set as data of address specified by Select Address +N-1.

(c) Configuration Unavailable for Transmission (In this case, only Select Address1 is set.)



(Note) If any data is transmitted as Select Address 2 next to data, it is recognized as data, not as Select Address 2.

(4) Slave Address

	MSB							LSB	
A6	A5	A4	A3	A2	A1	A0	R/W		
1	0	0	0	0	0	0	0		80H

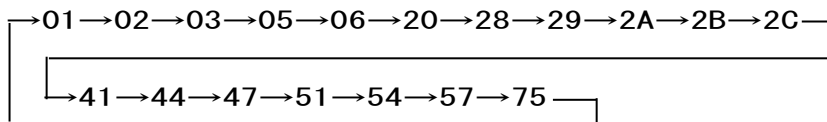
(5) Select Address & Data

Items	Select Address (hex)	Data								
		MSB		Data				LSB		
		D7	D6	D5	D4	D3	D2	D1	D0	
Initial setup 1	01	Advanced switch ON/OFF	0	Advanced switch time of Input Gain/Volume Tone/Fader/Loudness			0	0	Advanced switch time of Mute	
Initial setup 2	02	0	0	0	0	0	0	0	0	
Initial setup 3	03	0	0	0	1	0	0	0	1	
Input Selector	05	0	0	0	Input selector					
Input gain	06	Mute ON/OFF	0	0	Input Gain					
Volume gain	20	Volume Gain / Attenuation								
Fader 1ch Front	28	Fader / Attenuation								
Fader 2ch Front	29	Fader / Attenuation								
Fader 1ch Rear	2A	Fader / Attenuation								
Fader 2ch Rear	2B	Fader / Attenuation								
Fader Subwoofer	2C	Fader / Attenuation								
Bass setup	41	0	0	Bass fo		0	0	Bass Q		
Test mode 1	44	0	0	0	0	0	0	0	0	
Treble setup	47	0	0	Treble fo		0	0	0	Treble Q	
Bass gain	51	Bass Boost/Cut	0	0	Bass Gain					
Test mode 2	54	1	0	0	0	0	0	0	0	
Treble gain	57	Treble Boost/Cut	0	0	Treble Gain					
Loudness Gain	75	0	Loudness Hicut		Loudness Gain					
System Reset	FE	1	0	0	0	0	0	0	1	

 Advanced switch

Note

1. The Advanced Switch works in the latch part while changing from one function to another.
2. Upon continuous data transfer, the Select Address rolls over because of the automatic increment function, as shown below.



3. For the function of Input Selector etc, Advanced Switch is not used. Therefore, please apply mute on the set side when changing these settings.
4. When using mute function of this IC at the time of changing input selector, please switch mute ON/OFF while waiting for advanced-mute time.

Select address 01 (hex)

Time	Advanced switch time of Mute							LSB	
	MSB D7	D6	D5	D4	D3	D2	D1	D0	
0.6msec	Advanced Switch ON/OFF	0	Advanced switch time of Input gain/Volume Tone/Fader/Loudness		0	0	0	0	
1.0msec							0	1	
1.4msec							1	0	
3.2msec							1	1	


Time	Advanced switch time of Input gain/Volume/Tone/Fader/Loudness							LSB	
	MSB D7	D6	D5	D4	D3	D2	D1	D0	
4.7 msec	Advanced Switch ON/OFF	0	0	0	0	0	Advanced switch Time of Mute		
7.1 msec			0	1					
11.2 msec			1	0					
14.4 msec			1	1					

Mode	Advanced switch ON/OFF							LSB	
	MSB D7	D6	D5	D4	D3	D2	D1	D0	
OFF	0	0	Advanced switch time of Input gain/Volume Tone/Fader/Loudness		0	0	Advanced switch Time of Mute		
ON	1								

Select address 05(hex)

Mode	Input Selector							LSB	
	MSB D7	D6	D5	D4	D3	D2	D1	D0	
Initial	0	0	0	0	0	0	0	0	
A					0	0	0	1	
B					0	0	1	0	
C					0	0	1	1	
D diff					0	1	1	1	
Input SHORT					1	0	0	1	
Prohibition					Other setting				

Input SHORT : The input impedance of each input terminal is lowered from 100kΩ(TYP) to 6 kΩ(TYP).
(For quick charge of coupling capacitor)

 : Initial condition

Select address 06 (hex)

Gain	MSB			Input Gain				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
0dB	Mute ON/OFF	0	0	0	0	0	0	0	
1dB				0	0	0	0	1	
2dB				0	0	0	1	0	
3dB				0	0	0	1	1	
4dB				0	0	1	0	0	
5dB				0	0	1	0	1	
6dB				0	0	1	1	0	
7dB				0	0	1	1	1	
8dB				0	1	0	0	0	
9dB				0	1	0	0	1	
10dB				0	1	0	1	0	
11dB				0	1	0	1	1	
12dB				0	1	1	0	0	
13dB				0	1	1	0	1	
14dB				0	1	1	1	0	
15dB				0	1	1	1	1	
16dB				1	0	0	0	0	
17dB				1	0	0	0	1	
18dB				1	0	0	1	0	
19dB				1	0	0	1	1	
20dB	1	0	1	0	0				
Prohibition	1	1	0	1	1				
	:	:	:	:	:				
	1	1	1	1	1				

Mode	MSB			Mute ON/OFF				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
OFF	0	0	0	Input Gain					
ON	1								

Select address 20, 28, 29, 2A, 2B, 2C (hex)

Gain & ATT	MSB			Vol. Fader Gain / Attenuation				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
Prohibition	0	0	0	0	0	0	0	0	
	0	0	0	0	0	0	0	1	
	:	:	:	:	:	:	:	:	
	0	1	1	1	0	0	0	0	
15dB	0	1	1	1	0	0	0	1	
14dB	0	1	1	1	0	0	1	0	
13dB	0	1	1	1	0	0	1	1	
:	:	:	:	:	:	:	:	:	
-77dB	1	1	0	0	1	1	0	1	
-78dB	1	1	0	0	1	1	1	0	
-79dB	1	1	0	0	1	1	1	1	
Prohibition	1	1	0	1	0	0	0	0	
	:	:	:	:	:	:	:	:	
	1	1	1	1	1	1	1	0	
-∞dB	1	1	1	1	1	1	1	1	

(Only 0dB to -∞dB are available at address 28, 29, 2A, 2B, 2C.)

 : Initial condition

Select address 41 (hex)

Q factor	MSB		Bass Q Factor				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0
0.5	0	0	Bass fo		0	0	0	0
1.0							0	1
1.5							1	0
2.0							1	1

fo	MSB		Bass fo				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0
60Hz	0	0	0	0	0	0	Bass Q factor	
80Hz			0	1				
100Hz			1	0				
120Hz			1	1				

Select address 47 (hex)

Q factor	MSB		Treble Q Factor				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0
0.75	0	0	Treble fo		0	0	0	0
1.25								1

fo	MSB		Treble fo				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0
7.5kHz	0	0	0	0	0	0	0	Treble Q factor
10kHz			0	1				
12.5kHz			1	0				
15kHz			1	1				

: Initial condition

Select address 51, 57 (hex)

Gain	MSB		Bass/ Treble Gain				LSB		
	D7	D6	D5	D4	D3	D2	D1	D0	
0dB	Bass/ Treble Boost /cut	0	0	0	0	0	0	0	
1dB				0	0	0	0	1	
2dB				0	0	0	1	0	
3dB				0	0	0	1	1	
4dB				0	0	0	1	0	0
5dB				0	0	0	1	0	1
6dB				0	0	0	1	1	0
7dB				0	0	0	1	1	1
8dB				0	1	0	0	0	0
9dB				0	1	0	0	0	1
10dB				0	1	0	1	1	0
11dB				0	1	0	1	0	1
12dB				0	1	1	1	0	0
13dB				0	1	1	1	0	1
14dB				0	1	1	1	1	0
15dB				0	1	1	1	1	1
16dB				1	0	0	0	0	0
17dB				1	0	0	0	0	1
18dB				1	0	0	1	1	0
19dB				1	0	0	1	0	1
20dB	1	0	1	0	0	0			
Prohibition	1	0	1	0	1	0	1		
	:	:	:	:	:	:			
	1	1	1	1	1	0			
	1	1	1	1	1	1			


Mode	MSB		Bass/ Treble Boost/Cut				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0
Boost	0	0	0	Bass/Treble Gain				
Cut	1							

: Initial condition

Select address 75 (hex)

Mode	MSB			Loudness Hicut				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
Hicut1	0	0	0	Loudness Gain					
Hicut2		0	1						
Hicut3		1	0						
Hicut4		1	1						

Gain	MSB			Loudness Gain				LSB	
	D7	D6	D5	D4	D3	D2	D1	D0	
0dB	0	Loudness Hicut		0	0	0	0	0	
1dB				0	0	0	0	1	
2dB				0	0	0	1	0	
3dB				0	0	0	1	1	
4dB				0	0	1	0	0	
5dB				0	0	1	0	1	
6dB				0	0	1	1	0	
7dB				0	0	1	1	1	
8dB				0	1	0	0	0	
9dB				0	1	0	0	1	
10dB				0	1	0	1	0	
11dB				0	1	0	1	1	
12dB				0	1	1	0	0	
13dB				0	1	1	0	1	
14dB				0	1	1	1	0	
15dB				0	1	1	1	1	
16dB				1	0	0	0	0	
17dB				1	0	0	0	1	
18dB				1	0	0	1	0	
19dB				1	0	0	1	1	
20dB	1	0	1	0	0				
Prohibition	:	:	:	:	:				
	1	1	1	1	1				

 : Initial condition

(6) About Power ON Reset

Built-in IC initialization is made during power ON of the supply voltage. Please send initial data to all addresses at supply voltage on. And please turn ON mute at the set side until this initial data is sent.

Parameter	Symbol	Limit			Unit	Conditions
		Min	Typ	Max		
Rise Time of VCC	t _{RISE}	33	-	-	μsec	V _{CC} rise time from 0V to 5V
VCC Voltage of Release Power ON Reset	V _{POR}	-	4.1	-	V	

(7) About External Compulsory Mute Terminal

It is possible to force mute externally by setting an input voltage to the MUTE terminal.

Mute Voltage Condition	Mode
GND to 1.0V	MUTE ON
2.3V to V _{CC}	MUTE OFF

Establish the voltage of MUTE in the condition to be defined.

Application information

1. Function and Specifications

Function	Specifications
Input selector	<ul style="list-style-type: none"> • Stereo 3 input • Differential 1 input
Input gain	<ul style="list-style-type: none"> • +20dB to 0dB (1dB step) • Possible to use "Advanced switch" for prevention of switching noise.
Mute	<ul style="list-style-type: none"> • Possible to use "Advanced switch" for prevention of switching noise.
Volume	<ul style="list-style-type: none"> • +15dB to -79dB (1dB step) , -∞dB • Possible to use "Advanced switch" for prevention of switching noise.
Bass	<ul style="list-style-type: none"> • +20dB to -20dB (1dB step) • Possible to use "Advanced switch" at changing gain • Q=0.5, 1, 1.5, 2 • fo=60, 80, 100, 120Hz
Treble	<ul style="list-style-type: none"> • +20dB to -20dB (1dB step) • Possible to use "Advanced switch" at changing gain • Q=0.75, 1.25 • fo=7.5k, 10k, 12.5k, 15kHz
Fader	<ul style="list-style-type: none"> • 0dB to -79dB, -∞dB • Possible to use "Advanced switch" for prevention of switching noise.
Loudness	<ul style="list-style-type: none"> • 20dB to 0dB(1dB step) • fo=800Hz • Possible to use "Advanced switch" for prevention of switching noise.

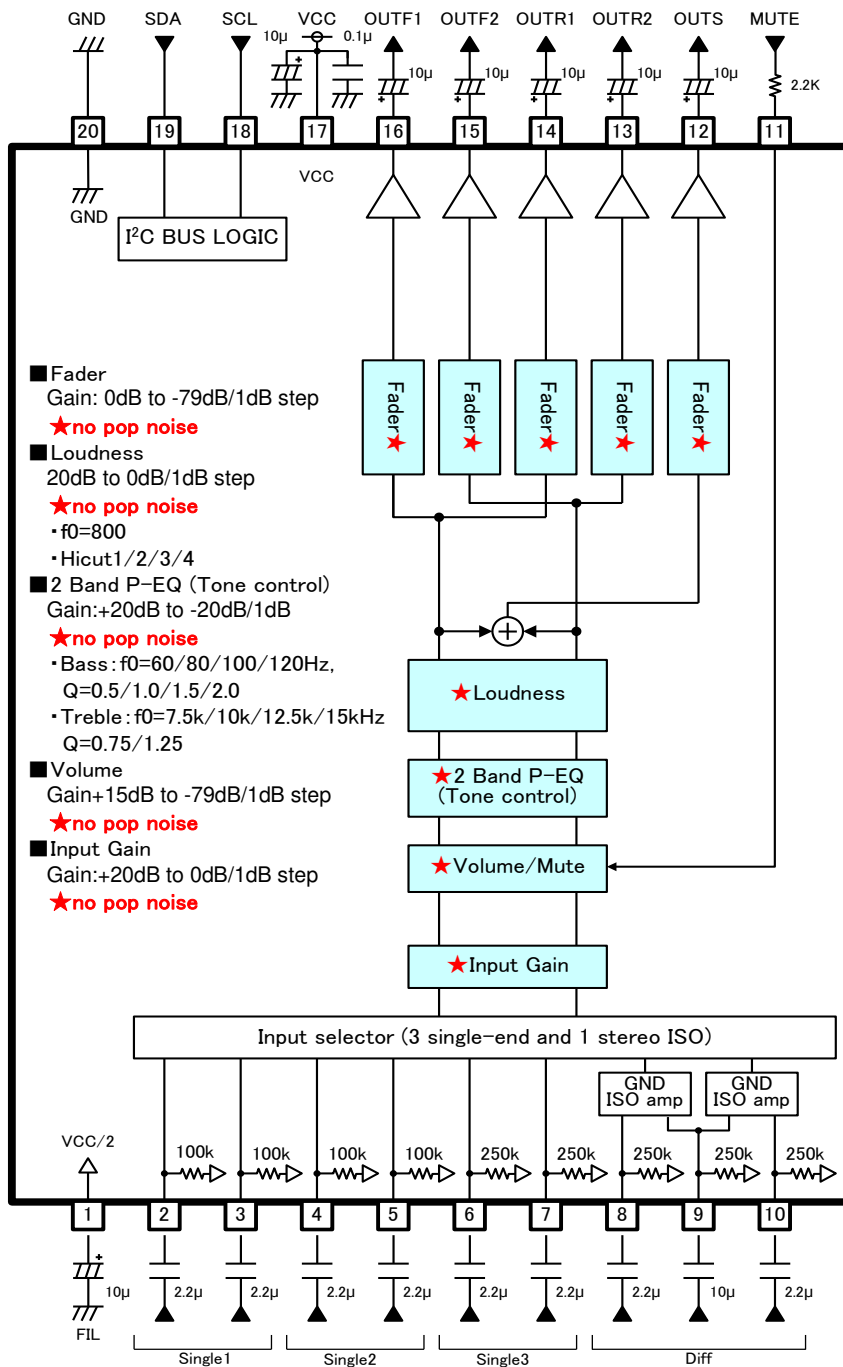
2. Volume / Fader Volume Attenuation Data

(dB)	D7	D6	D5	D4	D3	D2	D1	D0	(dB)	D7	D6	D5	D4	D3	D2	D1	D0
+15	0	1	1	1	0	0	0	1	-33	1	0	1	0	0	0	0	1
+14	0	1	1	1	0	0	1	0	-34	1	0	1	0	0	0	1	0
+13	0	1	1	1	0	0	1	1	-35	1	0	1	0	0	0	1	1
+12	0	1	1	1	0	1	0	0	-36	1	0	1	0	0	1	0	0
+11	0	1	1	1	0	1	0	1	-37	1	0	1	0	0	1	0	1
+10	0	1	1	1	0	1	1	0	-38	1	0	1	0	0	1	1	0
+9	0	1	1	1	0	1	1	1	-39	1	0	1	0	0	1	1	1
+8	0	1	1	1	1	0	0	0	-40	1	0	1	0	1	0	0	0
+7	0	1	1	1	1	0	0	1	-41	1	0	1	0	1	0	0	1
+6	0	1	1	1	1	0	1	0	-42	1	0	1	0	1	0	1	0
+5	0	1	1	1	1	0	1	1	-43	1	0	1	0	1	0	1	1
+4	0	1	1	1	1	1	0	0	-44	1	0	1	0	1	1	0	0
+3	0	1	1	1	1	1	0	1	-45	1	0	1	0	1	1	0	1
+2	0	1	1	1	1	1	1	0	-46	1	0	1	0	1	1	1	0
+1	0	1	1	1	1	1	1	1	-47	1	0	1	0	1	1	1	1
0	1	0	0	0	0	0	0	0	-48	1	0	1	1	0	0	0	0
-1	1	0	0	0	0	0	0	1	-49	1	0	1	1	0	0	0	1
-2	1	0	0	0	0	0	1	0	-50	1	0	1	1	0	0	1	0
-3	1	0	0	0	0	0	1	1	-51	1	0	1	1	0	0	1	1
-4	1	0	0	0	0	1	0	0	-52	1	0	1	1	0	1	0	0
-5	1	0	0	0	0	1	0	1	-53	1	0	1	1	0	1	0	1
-6	1	0	0	0	0	1	1	0	-54	1	0	1	1	0	1	1	0
-7	1	0	0	0	0	1	1	1	-55	1	0	1	1	0	1	1	1
-8	1	0	0	0	1	0	0	0	-56	1	0	1	1	1	0	0	0
-9	1	0	0	0	1	0	0	1	-57	1	0	1	1	1	0	0	1
-10	1	0	0	0	1	0	1	0	-58	1	0	1	1	1	0	1	0
-11	1	0	0	0	1	0	1	1	-59	1	0	1	1	1	0	1	1
-12	1	0	0	0	1	1	0	0	-60	1	0	1	1	1	1	0	0
-13	1	0	0	0	1	1	0	1	-61	1	0	1	1	1	1	0	1
-14	1	0	0	0	1	1	1	0	-62	1	0	1	1	1	1	1	0
-15	1	0	0	0	1	1	1	1	-63	1	0	1	1	1	1	1	1
-16	1	0	0	1	0	0	0	0	-64	1	1	0	0	0	0	0	0
-17	1	0	0	1	0	0	0	1	-65	1	1	0	0	0	0	0	1
-18	1	0	0	1	0	0	1	0	-66	1	1	0	0	0	0	1	0
-19	1	0	0	1	0	0	1	1	-67	1	1	0	0	0	0	1	1
-20	1	0	0	1	0	1	0	0	-68	1	1	0	0	0	1	0	0
-21	1	0	0	1	0	1	0	1	-69	1	1	0	0	0	1	0	1
-22	1	0	0	1	0	1	1	0	-70	1	1	0	0	0	1	1	0
-23	1	0	0	1	0	1	1	1	-71	1	1	0	0	0	1	1	1
-24	1	0	0	1	1	0	0	0	-72	1	1	0	0	1	0	0	0
-25	1	0	0	1	1	0	0	1	-73	1	1	0	0	1	0	0	1
-26	1	0	0	1	1	0	1	0	-74	1	1	0	0	1	0	1	0
-27	1	0	0	1	1	0	1	1	-75	1	1	0	0	1	0	1	1
-28	1	0	0	1	1	1	0	0	-76	1	1	0	0	1	1	0	0
-29	1	0	0	1	1	1	0	1	-77	1	1	0	0	1	1	0	1
-30	1	0	0	1	1	1	1	0	-78	1	1	0	0	1	1	1	0
-31	1	0	0	1	1	1	1	1	-79	1	1	0	0	1	1	1	1
-32	1	0	1	0	0	0	0	0	-∞	1	1	1	1	1	1	1	1

For Fader Volume only 0dB to -∞dB are available.

: Initial condition

3. Application Circuit



Notes on Wiring

- ① Please connect the decoupling capacitor of the power supply in the shortest possible distance to GND.
- ② GND lines should be one-point connected.
- ③ Wiring pattern of Digital should be away from that of Analog unit and cross-talk should not be acceptable.
- ④ SCL and SDA lines of I²C BUS should not be parallel if possible.
The lines should be shielded, if they are adjacent to each other.
- ⑤ Analog input lines should not be parallel if possible. The lines should be shielded, if they are adjacent to each other.

Power Dissipation

About the thermal design of the IC

Characteristics of an IC have a great deal to do with the temperature at which it is used, and exceeding absolute maximum ratings may degrade and destroy the device. Careful consideration must be given to the heat of the IC from the two standpoints of immediate damage and long-term reliability of operation.

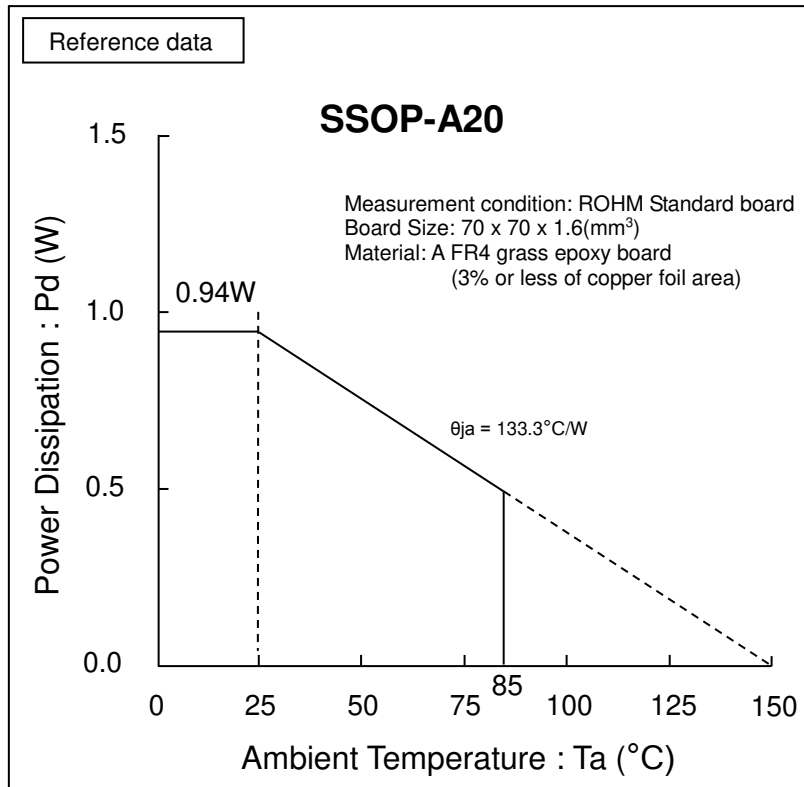


Figure 19. Temperature Derating Curve

(Note) Values are actual measurements and are not guaranteed.

Power dissipation values vary according to the board on which the IC is mounted.

I/O Equivalent Circuits

Terminal No.	Terminal Name	Terminal voltage	Equivalent Circuit	Terminal Description
2 3 4 5	A1 A2 B1 B2	4.25		A terminal for signal input. The input impedance is 100kΩ(typ).
6 7	C1 C2	4.25		A terminal for signal input. The input impedance is 250kΩ(typ).
8 9 10	DP1 DN DP2	4.25		Input terminal available to Single/Differential mode. The input impedance is 250kΩ(typ).
11	MUTE	—		A terminal for external compulsory mute. If terminal voltage is High level, the mute is OFF. And if the terminal voltage is Low level, the mute is ON.
12 13 14 15 16	OUTS OUTR2 OUTR1 OUTF2 OUTF1	4.25		A terminal for fader and Subwoofer output.

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

I/O Equivalent Circuit - continued

Terminal No.	Terminal Name	Terminal voltage	Equivalent Circuit	Terminal Description
17	VCC	8.5		Power supply terminal.
18	SCL	-		A terminal for clock input of I ² C BUS communication.
19	SDA	-		A terminal for data input of I ² C BUS communication.
20	GND	0		Ground terminal.
1	FIL	4.25		1/2 VCC terminal. Voltage for reference bias of analog signal system. The simple precharge circuit and simple discharge circuit for an external capacitor are built in.

Values in the pin explanation and input/output equivalent circuit are reference values only and are not guaranteed.

Operational Notes

1. Reverse Connection of Power Supply

Connecting the power supply in reverse polarity can damage the IC. Take precautions against reverse polarity when connecting the power supply, such as mounting an external diode between the power supply and the IC's power supply pins.

2. Power Supply Lines

Design the PCB layout pattern to provide low impedance supply lines. Separate the ground and supply lines of the digital and analog blocks to prevent noise in the ground and supply lines of the digital block from affecting the analog block. Furthermore, connect a capacitor to ground at all power supply pins. Consider the effect of temperature and aging on the capacitance value when using electrolytic capacitors.

3. Ground Voltage

Ensure that no pins are at a voltage below that of the ground pin at any time, even during transient condition.

4. Ground Wiring Pattern

When using both small-signal and large-current ground traces, the two ground traces should be routed separately but connected to a single ground at the reference point of the application board to avoid fluctuations in the small-signal ground caused by large currents. Also ensure that the ground traces of external components do not cause variations on the ground voltage. The ground lines must be as short and thick as possible to reduce line impedance.

5. Thermal Consideration

Should by any chance the power dissipation rating be exceeded the rise in temperature of the chip may result in deterioration of the properties of the chip. In case of exceeding this absolute maximum rating, increase the board size and copper area to prevent exceeding the Pd rating.

6. Recommended Operating Conditions

These conditions represent a range within which the expected characteristics of the IC can be approximately obtained. The electrical characteristics are guaranteed under the conditions of each parameter.

7. Inrush Current

When power is first supplied to the IC, it is possible that the internal logic may be unstable and inrush current may flow instantaneously due to the internal powering sequence and delays, especially if the IC has more than one power supply. Therefore, give special consideration to power coupling capacitance, power wiring, width of ground wiring, and routing of connections.

8. Operation Under Strong Electromagnetic Field

Operating the IC in the presence of a strong electromagnetic field may cause the IC to malfunction.

9. Testing on Application Boards

When testing the IC on an application board, connecting a capacitor directly to a low-impedance output pin may subject the IC to stress. Always discharge capacitors completely after each process or step. The IC's power supply should always be turned off completely before connecting or removing it from the test setup during the inspection process. To prevent damage from static discharge, ground the IC during assembly and use similar precautions during transport and storage.

10. Inter-pin Short and Mounting Errors

Ensure that the direction and position are correct when mounting the IC on the PCB. Incorrect mounting may result in damaging the IC. Avoid nearby pins being shorted to each other especially to ground, power supply and output pin. Inter-pin shorts could be due to many reasons such as metal particles, water droplets (in very humid environment) and unintentional solder bridge deposited in between pins during assembly to name a few.

11. Unused Input Pins

Input pins of an IC are often connected to the gate of a MOS transistor. The gate has extremely high impedance and extremely low capacitance. If left unconnected, the electric field from the outside can easily charge it. The small charge acquired in this way is enough to produce a significant effect on the conduction through the transistor and cause unexpected operation of the IC. So unless otherwise specified, unused input pins should be connected to the power supply or ground line.

Operational Notes – continued

12. Regarding the Input Pin of the IC

This monolithic IC contains P+ isolation and P substrate layers between adjacent elements in order to keep them isolated. P-N junctions are formed at the intersection of the P layers with the N layers of other elements, creating a parasitic diode or transistor. For example (refer to figure below):

When GND > Pin A and GND > Pin B, the P-N junction operates as a parasitic diode.
 When GND > Pin B, the P-N junction operates as a parasitic transistor.

Parasitic diodes inevitably occur in the structure of the IC. The operation of parasitic diodes can result in mutual interference among circuits, operational faults, or physical damage. Therefore, conditions that cause these diodes to operate, such as applying a voltage lower than the GND voltage to an input pin (and thus to the P substrate) should be avoided.

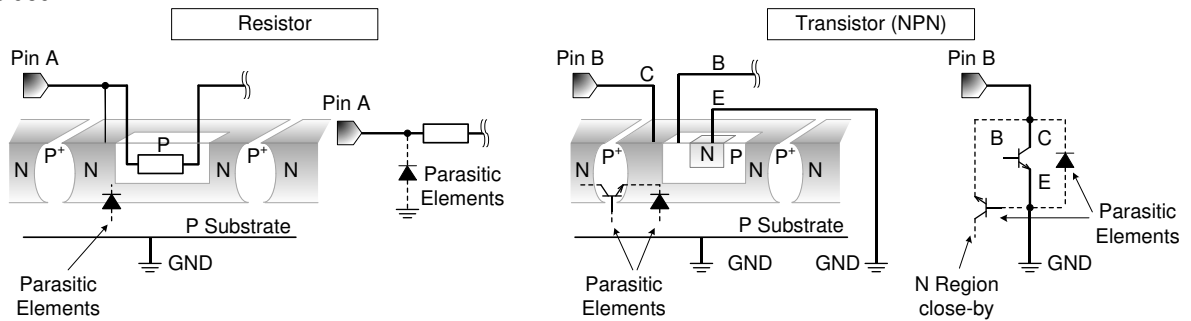
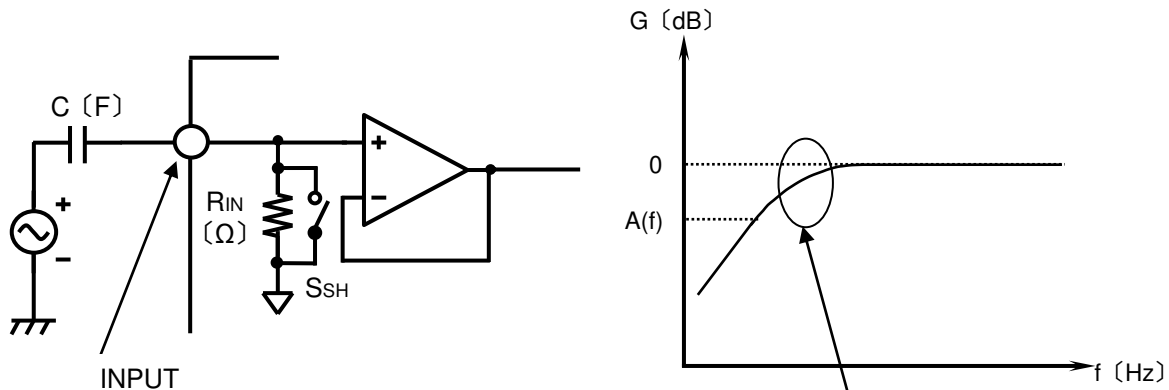


Figure 20. Example of monolithic IC structure

13. About a Signal Input Part

(a) About Input Coupling Capacitor Constant Value

In the input signal terminal, please decide the constant value of the input coupling capacitor C(F) that would be sufficient to form an RC characterized HPF with input impedance R_{IN}(Ω) inside the IC.



$$A(f) = \frac{(2\pi fCR_{IN})^2}{\sqrt{1 + (2\pi fCR_{IN})^2}}$$

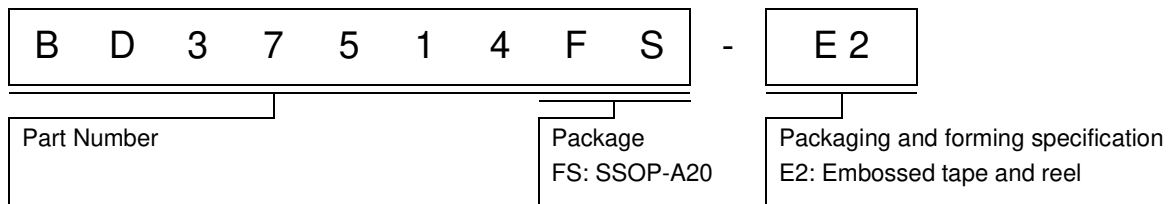
(b) About the Input Selector SHORT

SHORT mode is the command which makes switch S_{SH} =ON of input selector part so that the input impedance R_{IN} of all terminals becomes small. Switch S_{SH} is OFF when SHORT command is not selected. The constant time brought about by the small resistance inside and the capacitor outside the LSI becomes small when this command is used. The charge time of the capacitor becomes short. Since SHORT mode turns ON the switch of S_{SH} and makes it low impedance, please use it at no signal condition.

14. About Mute Terminal(Pin 11) when power supply is OFF

There should be no applied voltage across the Mute terminal (Pin 11) when power-supply is OFF. A resistor (about 2.2kΩ) should be connected in series to Mute terminal in case a voltage is supplied to Mute terminal. (Please refer Application Circuit Diagram.)

Ordering Information



Marking Diagram

